

# STARPOWER

SEMICONDUCTOR™

## IGBT

### GD600HFT170C3S

### Preliminary

Molding Type Module

1700V/600A 2 in one-package

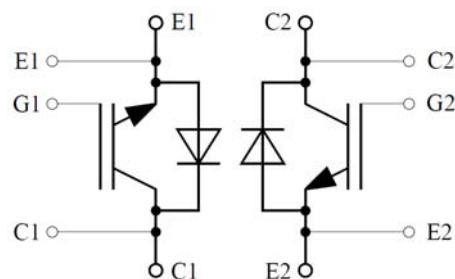
#### General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as high power converters.



#### Features

- Low  $V_{CE(sat)}$  trench IGBT technology
- 10 $\mu$ s short circuit capability
- $V_{CE(sat)}$  with positive temperature coefficient
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



Equivalent Circuit Schematic

#### Typical Applications

- AC Inverter Drives
- Uninterruptible Power Supply
- Wind Turbines

**Absolute Maximum Ratings**  $T_C=25^{\circ}\text{C}$  unless otherwise noted

| Symbol             | Description                                                                | GD600HFT170C3S | Units              |
|--------------------|----------------------------------------------------------------------------|----------------|--------------------|
| $V_{CES}$          | Collector-Emitter Voltage                                                  | 1700           | V                  |
| $V_{GES}$          | Gate-Emitter Voltage                                                       | $\pm 20$       | V                  |
| $I_C$              | Collector Current @ $T_C=25^{\circ}\text{C}$<br>@ $T_C=80^{\circ}\text{C}$ | 950            | A                  |
|                    |                                                                            | 600            |                    |
| $I_{CM(1)}$        | Pulsed Collector Current $t_p=1\text{ms}$                                  | 1200           | A                  |
| $I_F$              | Diode Continuous Forward Current                                           | 600            | A                  |
| $I_{FM}$           | Diode Maximum Forward Current                                              | 1200           | A                  |
| $P_D$              | Maximum power Dissipation @ $T_j=175^{\circ}\text{C}$                      | 3571           | W                  |
| $T_j$              | Maximum Junction Temperature                                               | 150            | $^{\circ}\text{C}$ |
| $T_{STG}$          | Storage Temperature Range                                                  | -40 to +125    | $^{\circ}\text{C}$ |
| $V_{ISO}$          | Isolation Voltage RMS, $f=50\text{Hz}$ , $t=1\text{min}$                   | 3400           | V                  |
| Mounting<br>Torque | Power Terminal Screw:M4                                                    | 1.8 to 2.1     | N.m                |
|                    | Power Terminal Screw:M8                                                    | 8.0 to 10      |                    |
|                    | Mounting Screw:M6                                                          | 4.25 to 5.75   | N.m                |

**Notes:**

(1) Repetitive rating: Pulse width limited by max. junction temperature

**Electrical Characteristics of IGBT**  $T_C=25^{\circ}\text{C}$  unless otherwise noted**Off Characteristics**

| Symbol        | Parameter                           | Test Conditions                                                     | Min. | Typ. | Max. | Units |
|---------------|-------------------------------------|---------------------------------------------------------------------|------|------|------|-------|
| $V_{(BR)CES}$ | Collector-Emitter Breakdown Voltage | $T_j=25^{\circ}\text{C}$                                            | 1700 |      |      | V     |
| $I_{CES}$     | Collector Cut-Off Current           | $V_{CE}=V_{CES}$ , $V_{GE}=0\text{V}$ ,<br>$T_j=25^{\circ}\text{C}$ |      |      | 5.0  | mA    |
| $I_{GES}$     | Gate-Emitter Leakage Current        | $V_{GE}=V_{GES}$ , $V_{CE}=0\text{V}$ ,<br>$T_j=25^{\circ}\text{C}$ |      |      | 400  | nA    |

**On Characteristics**

| Symbol        | Parameter                               | Test Conditions                                                        | Min. | Typ. | Max. | Units |
|---------------|-----------------------------------------|------------------------------------------------------------------------|------|------|------|-------|
| $V_{GE(th)}$  | Gate-Emitter Threshold Voltage          | $I_C=24\text{mA}$ , $V_{CE}=V_{GE}$ ,<br>$T_j=25^{\circ}\text{C}$      | 5.2  | 5.8  | 6.4  | V     |
| $V_{CE(sat)}$ | Collector to Emitter Saturation Voltage | $I_C=600\text{A}$ , $V_{GE}=15\text{V}$ ,<br>$T_j=25^{\circ}\text{C}$  |      | 2.00 | 2.45 | V     |
|               |                                         | $I_C=600\text{A}$ , $V_{GE}=15\text{V}$ ,<br>$T_j=125^{\circ}\text{C}$ |      | 2.40 |      |       |

## Switching Characteristics

| Symbol        | Parameter                                | Test Conditions                                                                                                  | Min. | Typ. | Max. | Units      |
|---------------|------------------------------------------|------------------------------------------------------------------------------------------------------------------|------|------|------|------------|
| $Q_G$         | Gate charge                              | $V_{GE} = -15 \dots +15V$                                                                                        |      | 7.0  |      | $\mu C$    |
| $t_{d(on)}$   | Turn-On Delay Time                       | $V_{CC}=900V, I_C=600A,$<br>$R_{Gon}=2.4\Omega,$<br>$R_{Goff}=3.0\Omega,$<br>$V_{GE} = \pm 15V, T_j=25^\circ C$  |      | 650  |      | ns         |
| $t_r$         | Rise Time                                |                                                                                                                  |      | 155  |      | ns         |
| $t_{d(off)}$  | Turn-Off Delay Time                      |                                                                                                                  |      | 1300 |      | ns         |
| $t_f$         | Fall Time                                |                                                                                                                  |      | 180  |      | ns         |
| $E_{on}$      | Turn-On Switching Loss                   |                                                                                                                  |      | 125  |      | mJ         |
| $E_{off}$     | Turn-Off Switching Loss                  |                                                                                                                  |      | 186  |      | mJ         |
| $t_{d(on)}$   | Turn-On Delay Time                       | $V_{CC}=900V, I_C=600A,$<br>$R_{Gon}=2.4\Omega,$<br>$R_{Goff}=3.0\Omega,$<br>$V_{GE} = \pm 15V, T_j=125^\circ C$ |      | 701  |      | ns         |
| $t_r$         | Rise Time                                |                                                                                                                  |      | 198  |      | ns         |
| $t_{d(off)}$  | Turn-Off Delay Time                      |                                                                                                                  |      | 1590 |      | ns         |
| $t_f$         | Fall Time                                |                                                                                                                  |      | 302  |      | ns         |
| $E_{on}$      | Turn-On Switching Loss                   |                                                                                                                  |      | 186  |      | mJ         |
| $E_{off}$     | Turn-Off Switching Loss                  |                                                                                                                  |      | 219  |      | mJ         |
| $C_{ies}$     | Input Capacitance                        | $V_{CE}=25V, f=1MHz,$<br>$V_{GE}=0V$                                                                             |      | 52.8 |      | nF         |
| $C_{oes}$     | Output Capacitance                       |                                                                                                                  |      | 2.20 |      | nF         |
| $C_{res}$     | Reverse Transfer Capacitance             |                                                                                                                  |      | 1.75 |      | nF         |
| $I_{SC}$      | SC Data                                  | $t_{sc} \leq 10\mu s, V_{GE}=15V,$<br>$T_j=125^\circ C, V_{CC}=1000V,$<br>$V_{CEM} \leq 1700V$                   |      | 2400 |      | A          |
| $R_{Gint}$    | Internal Gate Resistance                 |                                                                                                                  |      | 1.3  |      | $\Omega$   |
| $L_{CE}$      | Stray Inductance                         |                                                                                                                  |      | 20   |      | nH         |
| $R_{CC'+EE'}$ | Module Lead Resistance, Terminal to Chip |                                                                                                                  |      | 0.18 |      | m $\Omega$ |

Electrical Characteristics of DIODE  $T_C=25^\circ C$  unless otherwise noted

| Symbol    | Parameter                     | Test Conditions                      |                   | Min. | Typ. | Max. | Units   |
|-----------|-------------------------------|--------------------------------------|-------------------|------|------|------|---------|
| $V_F$     | Diode Forward Voltage         | $I_F=600A$                           | $T_j=25^\circ C$  |      | 1.80 | 2.20 | V       |
|           |                               |                                      | $T_j=125^\circ C$ |      | 1.90 |      |         |
| $Q_r$     | Recovered Charge              | $I_F=600A,$                          | $T_j=25^\circ C$  |      | 580  |      | $\mu C$ |
|           |                               |                                      | $T_j=125^\circ C$ |      | 640  |      |         |
| $I_{RM}$  | Peak Reverse Recovery Current | $V_R=900V,$<br>$di/dt=-3800A/\mu s,$ | $T_j=25^\circ C$  |      | 160  |      | A       |
|           |                               |                                      | $T_j=125^\circ C$ |      | 258  |      |         |
| $E_{rec}$ | Reverse Recovery Energy       | $V_{GE}=-15V$                        | $T_j=25^\circ C$  |      | 96   |      | mJ      |
|           |                               |                                      | $T_j=125^\circ C$ |      | 171  |      |         |

**Thermal Characteristics**

| Symbol          | Parameter                                               | Typ. | Max. | Units |
|-----------------|---------------------------------------------------------|------|------|-------|
| $R_{\theta JC}$ | Junction-to-Case (per IGBT)                             |      | 42   | K/kW  |
| $R_{\theta JC}$ | Junction-to-Case (per Diode)                            |      | 94   | K/kW  |
| $R_{\theta CS}$ | Case-to-Sink<br>(Conductive grease applied, per Module) | 6    |      | K/kW  |
| Weight          | Weight of Module                                        | 1500 |      | g     |

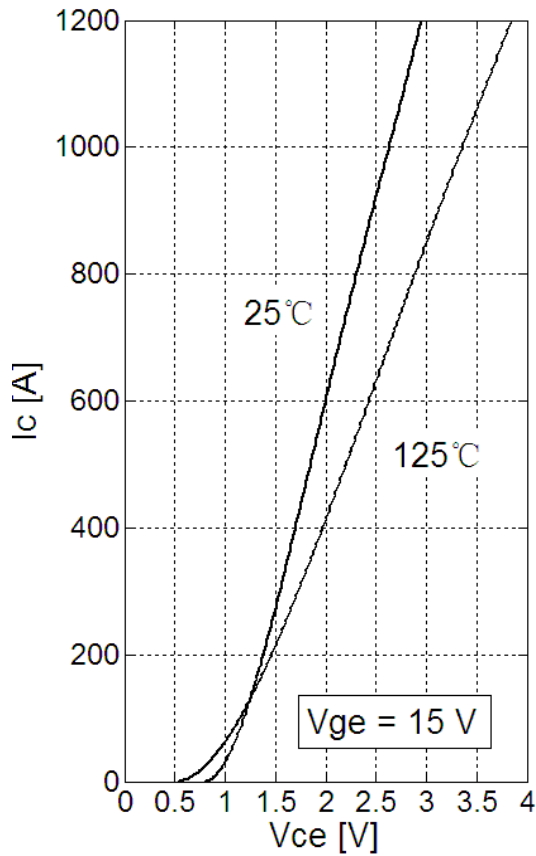


Fig 1. Typical IGBT Output Characteristics

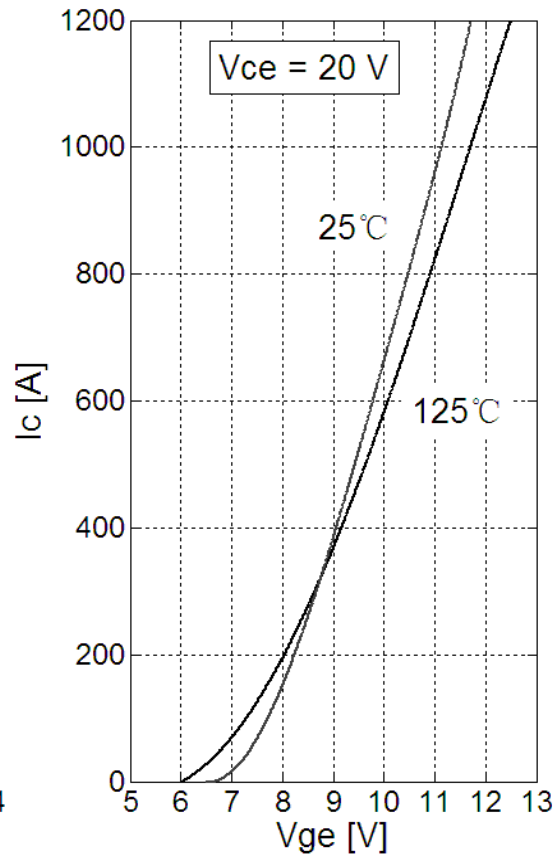
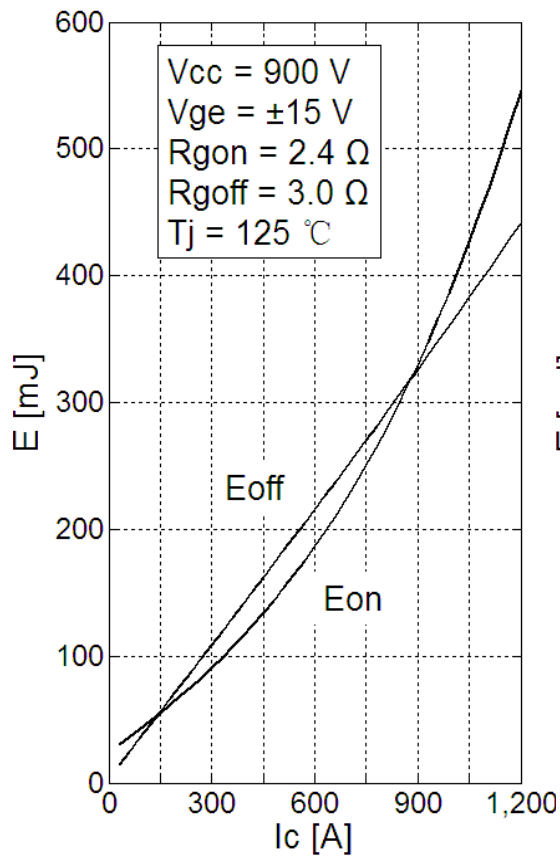
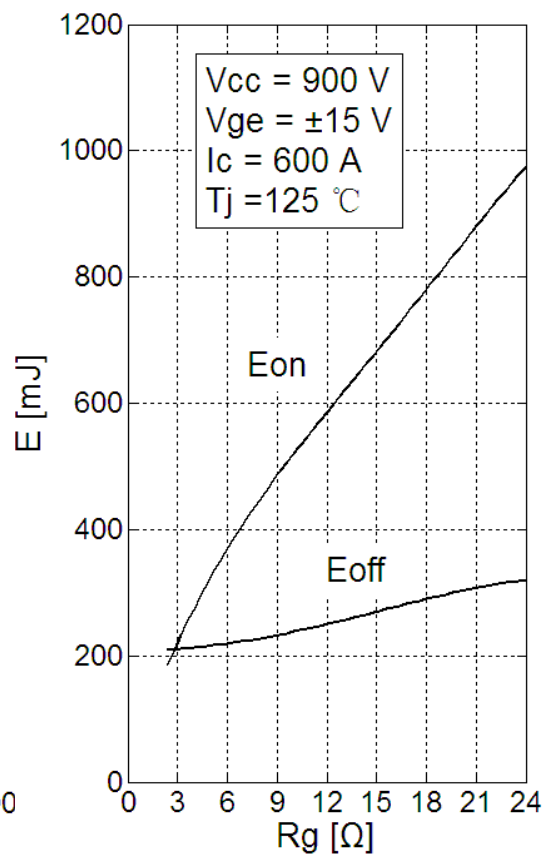


Fig 2. Typical IGBT Transfer Characteristics

Fig 3. IGBT Switching Loss vs.  $I_C$ Fig 4. IGBT Switching Loss vs.  $R_G$

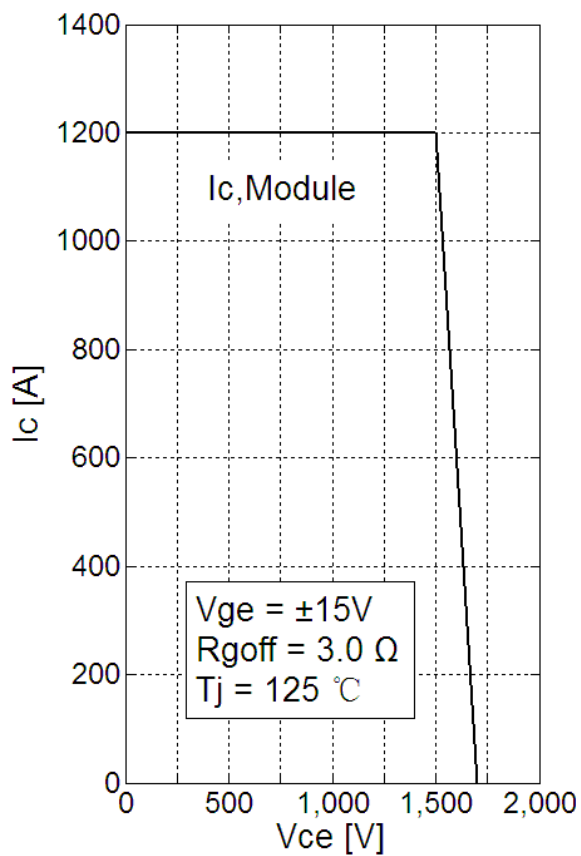


Fig 5. RBSOA

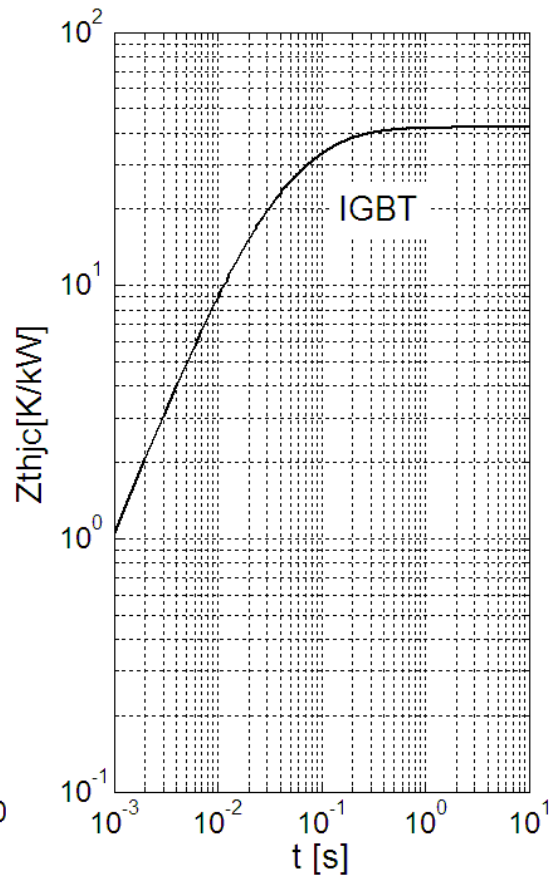


Fig 6. IGBT Transient Thermal Impedance

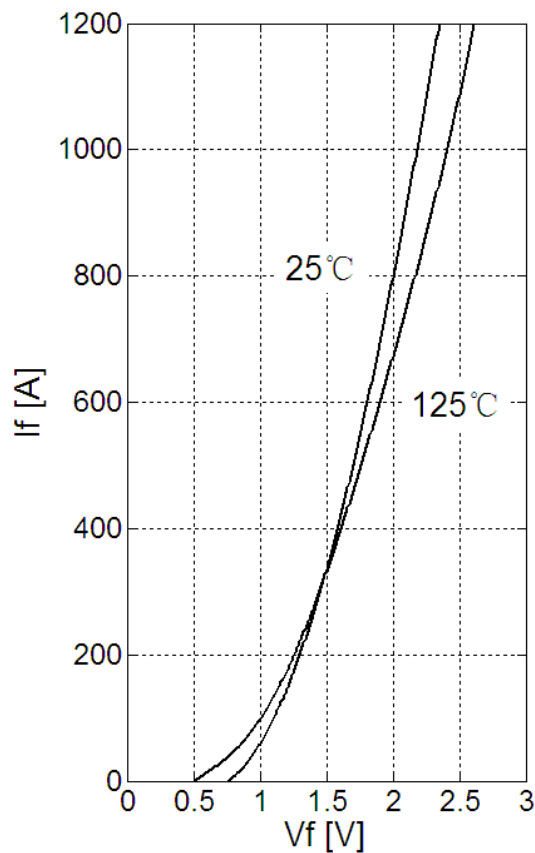
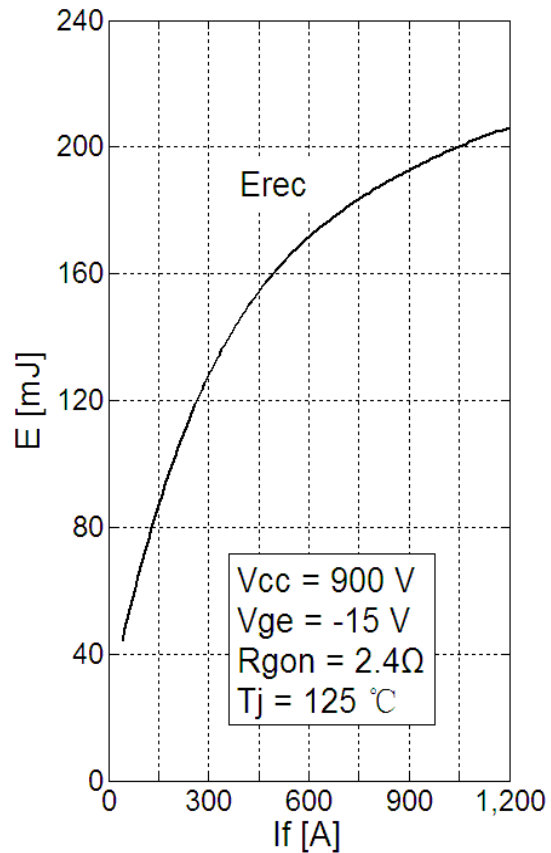


Fig 7. Diode Forward Characteristics

Fig 8. Diode Switching Loss vs.  $I_c$

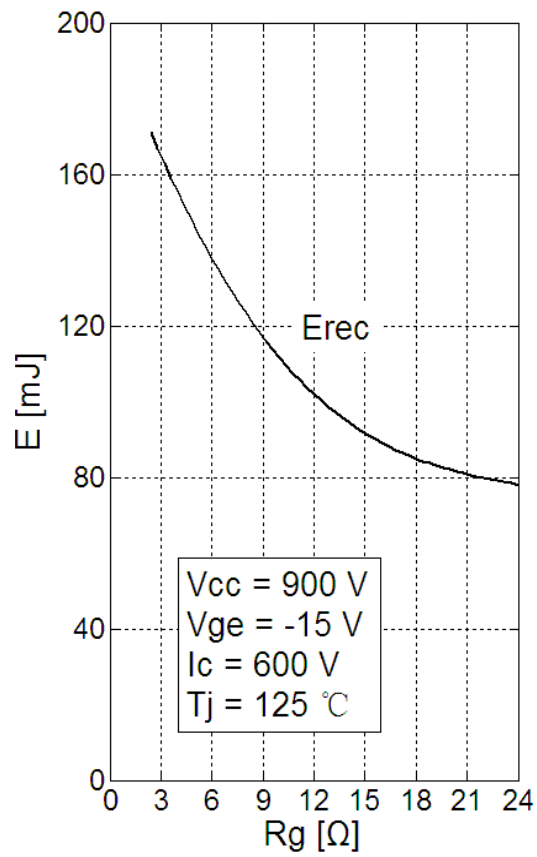
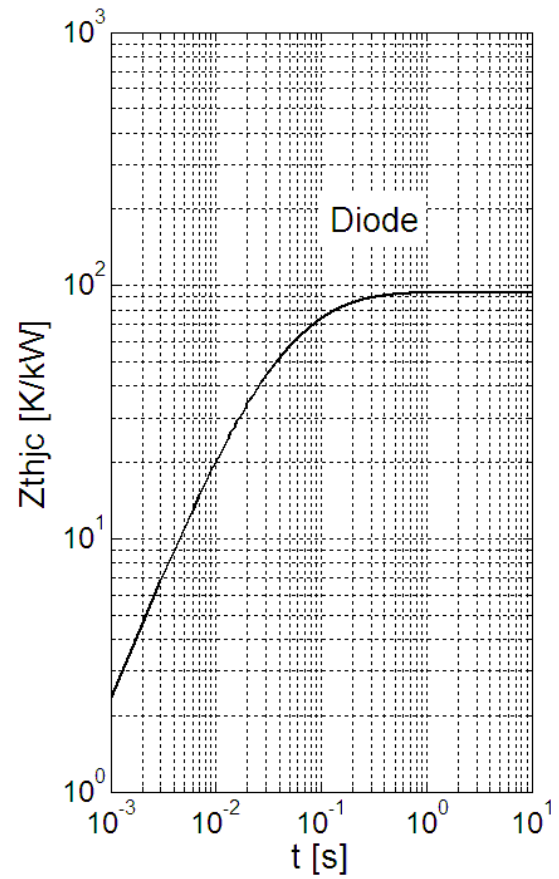
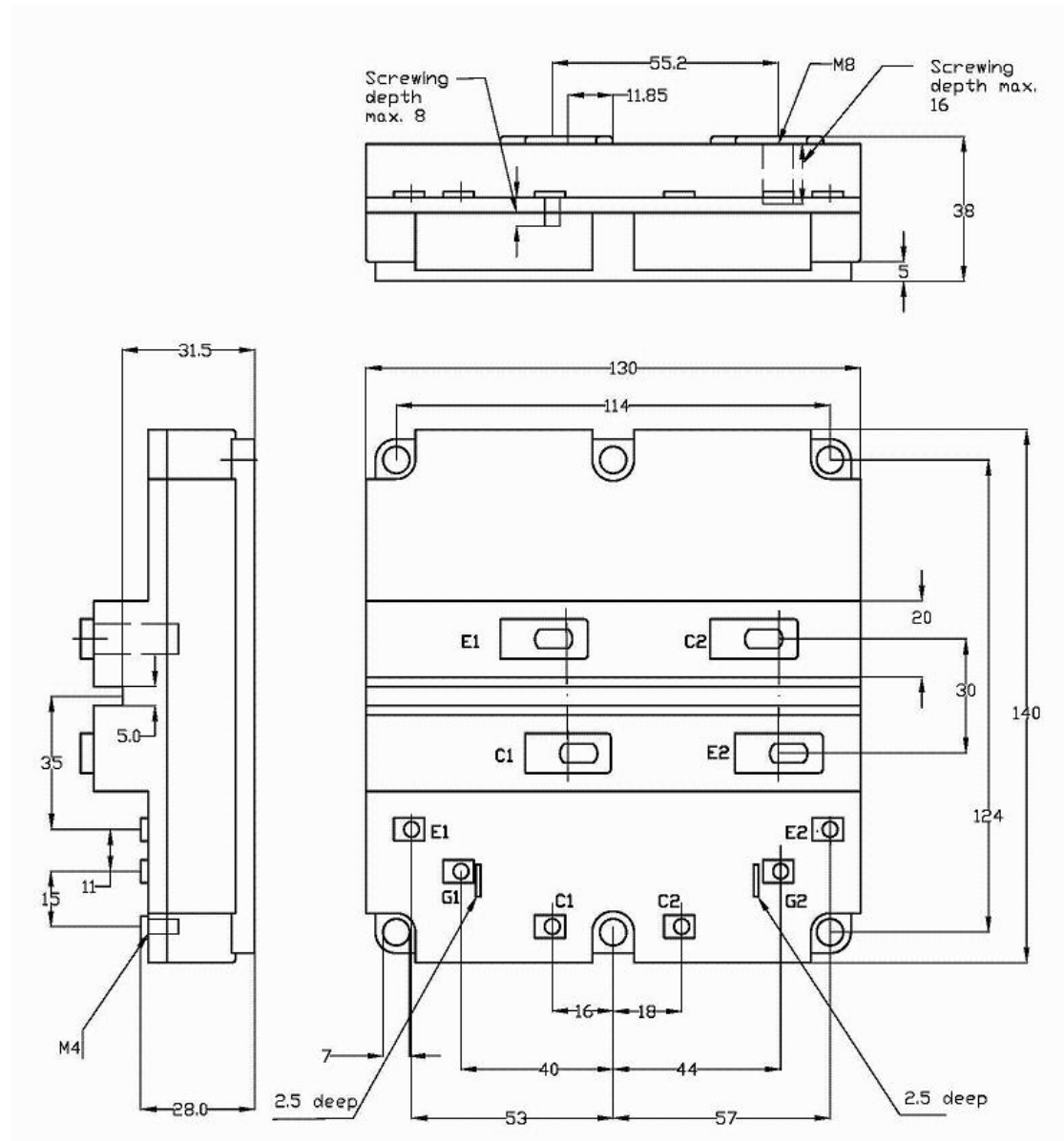
Fig9. Diode Switching Loss vs.  $R_g$ 

Fig 10. Diode Transient Thermal Impedance

## Package Dimension

Dimensions in Millimeters



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